



**THE DATASHEET OF
GMF05C-HS3-GS08**



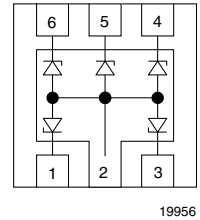
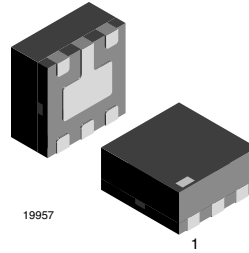
5-Line ESD Protection Diode Array in LLP75-6A

Features

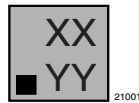
- Ultra compact LLP75-6A package
- 5-line ESD-protection
- Surge immunity acc. IEC 61000-4-5 $I_{PPM} > 12\text{ A}$
- Low leakage current $I_R < 1\ \mu\text{A}$
- ESD-immunity acc. IEC 61000-4-2 $\pm 30\text{ kV}$ contact discharge $\pm 30\text{ kV}$ air discharge
- Working voltage range $V_{RWM} = 5\text{ V}$
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



RoHS
COMPLIANT
GREEN
(5-2008)*



Marking (example only)



Dot = Pin 1 marking
XX = Date code
YY = Type code (see table below)

Ordering Information

Device name	Ordering code	Taped units per reel (8 mm tape on 7" reel)	Minimum order quantity
GMF05C-HS3	GMF05C-HS3-GS08	3000	15000

Package Data

Device name	Package name	Type code	Weight	Molding compound flammability rating	Moisture sensitivity level	Soldering conditions
GMF05C-HS3	LLP75-6A	F5	5.2 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

* Please see document "Vishay Green and Halogen-Free Definitions (5-2008)" <http://www.vishay.com/doc?99902>

Absolute Maximum Ratings

Rating	Test condition	Symbol	Value	Unit	
Peak pulse current	BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2); acc. IEC 61000-4-5; $t_p = 8/20 \mu\text{s}$; single shot	I_{PPM}	12	A	
Peak pulse power	BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2); acc. IEC 61000-4-5; $t_p = 8/20 \mu\text{s}$; single shot	P_{PP}	200	W	
ESD immunity	acc. IEC61000-4-2; 10 pulses BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2)	contact discharge	V_{ESD}	± 30	kV
		air discharge	V_{ESD}	± 30	kV
Operating temperature	Junction temperature	T_J	- 55 to + 125	$^{\circ}\text{C}$	
Storage temperature		T_{STG}	- 55 to + 150	$^{\circ}\text{C}$	

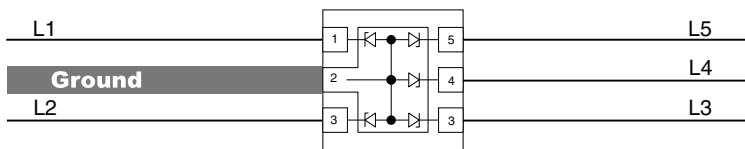
BiAs-Mode (5-line Bidirectional Asymmetrical protection mode)

With the **GMF05C-HS3** up to 5 signal- or data-lines (L1 - L5) can be protected against voltage transients. With pin 2 connected to ground and pin 1; 3 up to pin 6 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified **Maximum Reverse Working Voltage (V_{RWM})** the protection diode between data line and ground offer a high isolation to the ground line. The protection device behaves like an open switch.

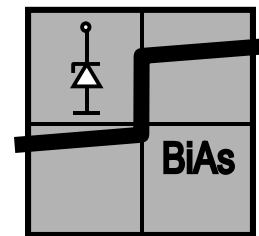
As soon as any positive transient voltage signal exceeds the break through voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The **Clamping Voltage (V_C)** is defined by the **Breakthrough Voltage (V_{BR})** level plus the voltage drop at the series impedance (resistance and inductance) of the protection device.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction of the protection diode. The low **Forward Voltage (V_F)** clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the **GMF05C-HS3** clamping behaviour is **Bidirectional** and **Asymmetrical (BiAs)**.



20739



Electrical Characteristics

Ratings at 25 °C, ambient temperature unless otherwise specified

GMF05C-HS3

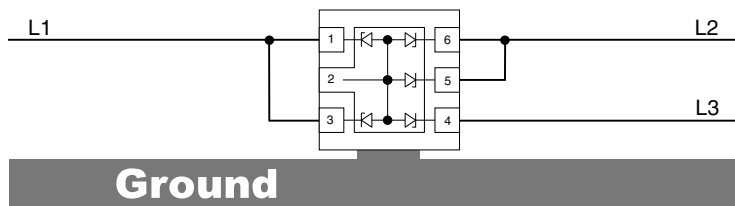
BiAs mode: each input (pin 1; 3 - pin 6) to ground (pin 2)

Parameter	Test conditions/remarks	Symbol	Min.	Typ.	Max.	Unit
Protection paths	number of line which can be protected	N lines			5	lines
Reverse working voltage	at $I_R = 1 \mu\text{A}$	V_{RWM}	5			V
Reverse current	at $V_R = V_{RWM} = 5 \text{ V}$	I_R		< 0.1	1	μA
Reverse breakdown voltage	at $I_R = 1 \text{ mA}$	V_{BR}	6		8	V
Reverse clamping voltage	at $I_{PP} = 12 \text{ A acc. IEC 61000-4-5}$	V_C			12.5	V
	at $I_{PP} = 1 \text{ A acc. IEC 61000-4-5}$	V_C		7.8	9.5	V
Forward clamping voltage	at $I_F = 12 \text{ A acc. IEC 61000-4-5}$	V_F			5.5	V
	at $I_{PP} = 1 \text{ A acc. IEC 61000-4-5}$	V_F		1.5		V
Capacitance	at $V_R = 0 \text{ V}; f = 1 \text{ MHz}$	C_D		126	150	pF
	at $V_R = 2.5 \text{ V}; f = 1 \text{ MHz}$	C_D		76		pF

If a higher surge current or **Peak Pulse current (I_{PP})** is needed, some protection diodes in the **GMF05C-HS3** can also be used in parallel in order to "multiply" the performance.

If two diodes are switched in parallel you get

- double surge power = double peak pulse current ($2 \times I_{PPM}$)
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line **Capacitance** ($2 \times C_D$)
- double **Reverse leakage current** ($2 \times I_R$)



20740

Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

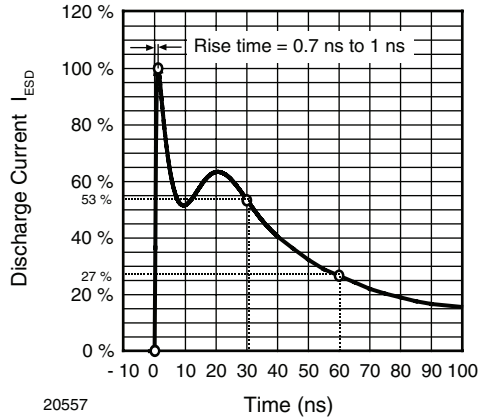


Figure 1. ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω /150 pF)

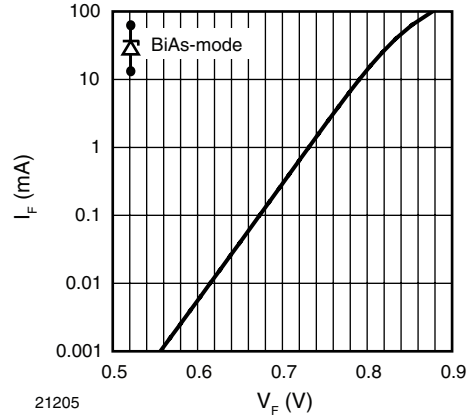


Figure 4. Typical Forward Current I_F vs. Forward Voltage V_F

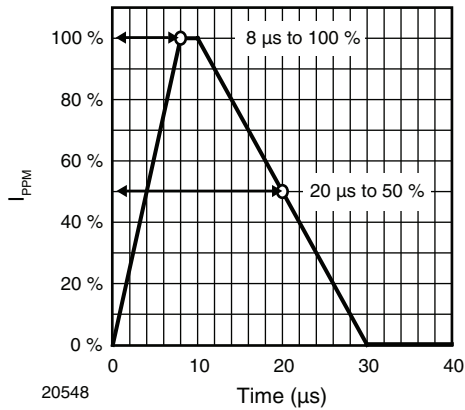


Figure 2. 8/20 μs Peak Pulse Current Wave Form (acc. IEC 61000-4-5)

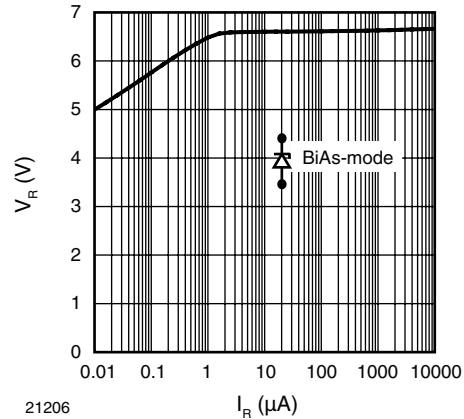


Figure 5. Typical Reverse Voltage V_R vs. Reverse Current I_R

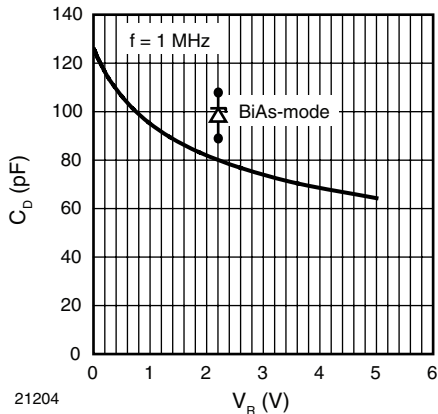


Figure 3. Typical Capacitance C_D vs. Reverse Voltage V_R

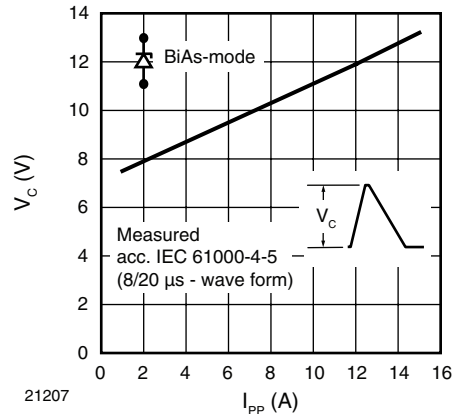


Figure 6. Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}

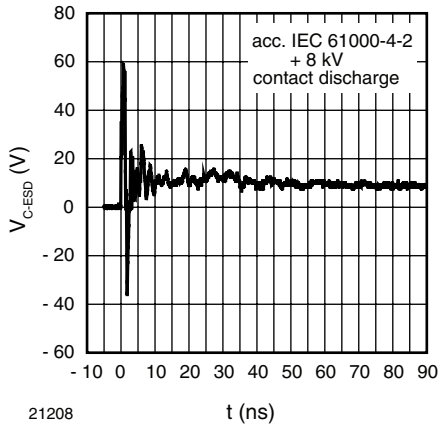


Figure 7. Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

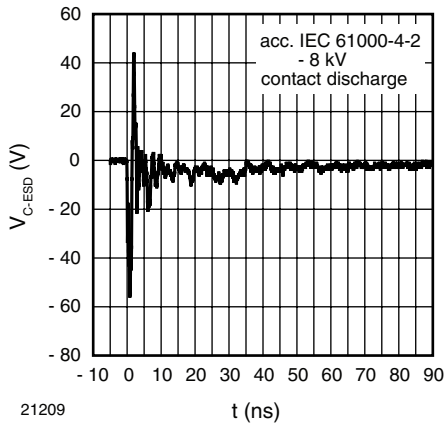


Figure 8. Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

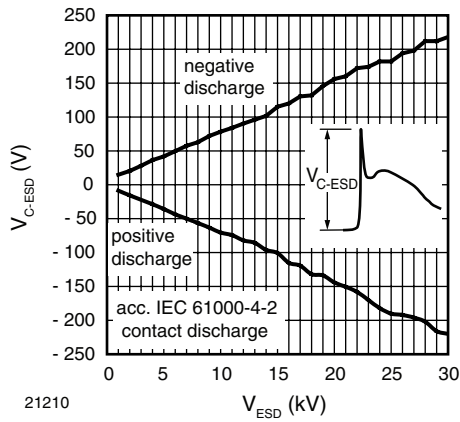
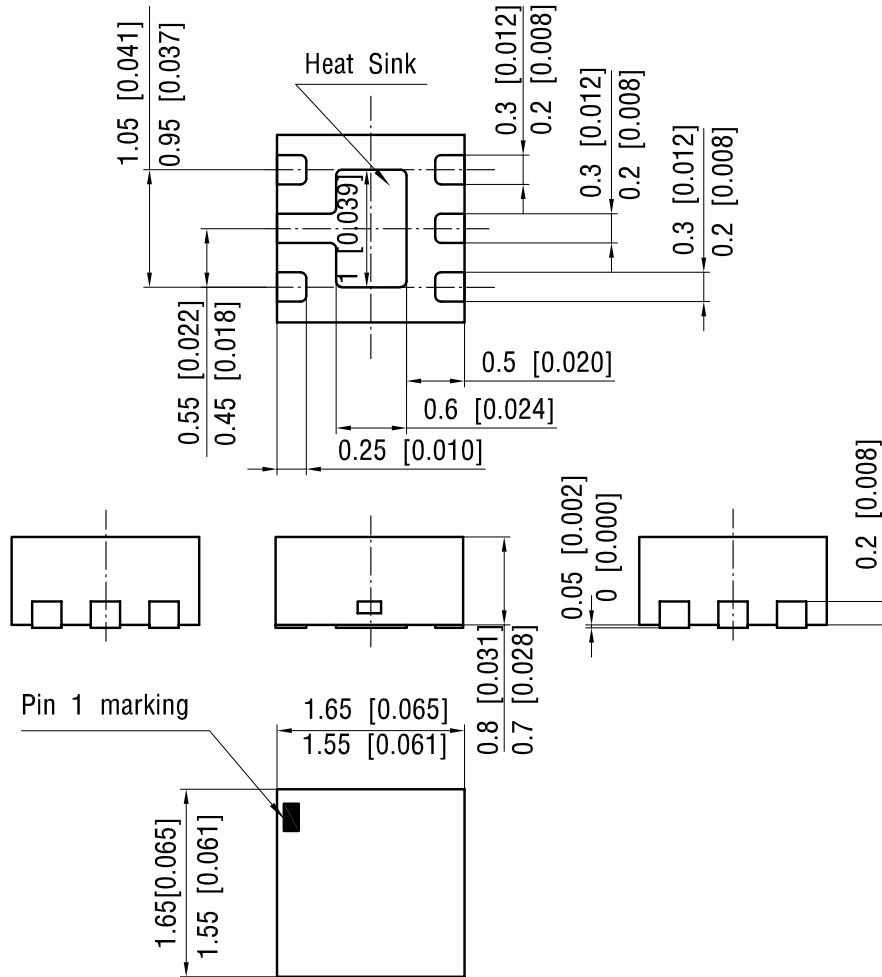
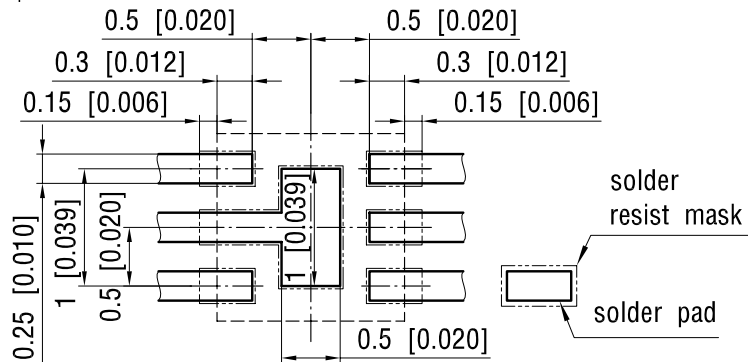


Figure 9. Typical Peak Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

Package Dimensions in millimeters (inches): **LLP75-6A**



foot print recommendation:



Document no.: S8-V-3906.02-001 (4)
 Created - Date: 20.December 2004
 Rev. b - Date: 12.January 2006
 18058



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

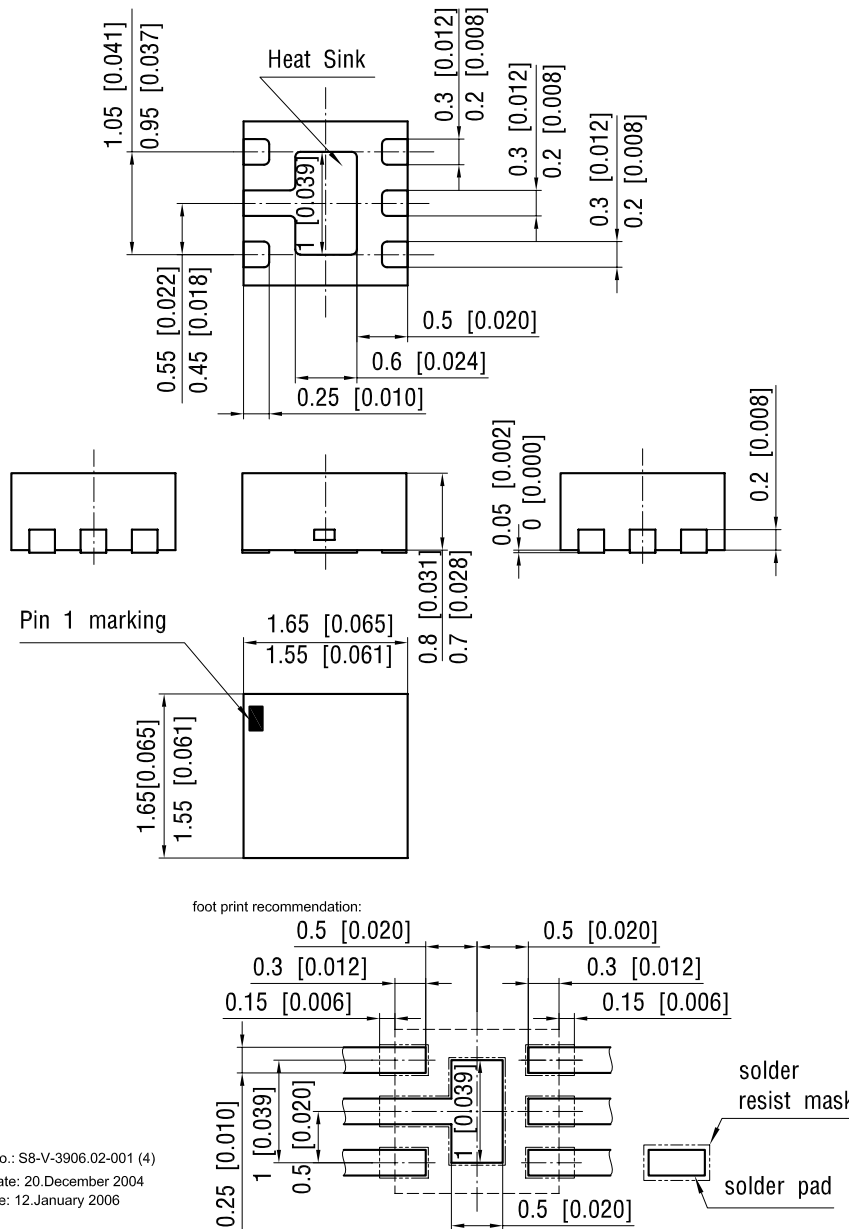
We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

LLP75-6A

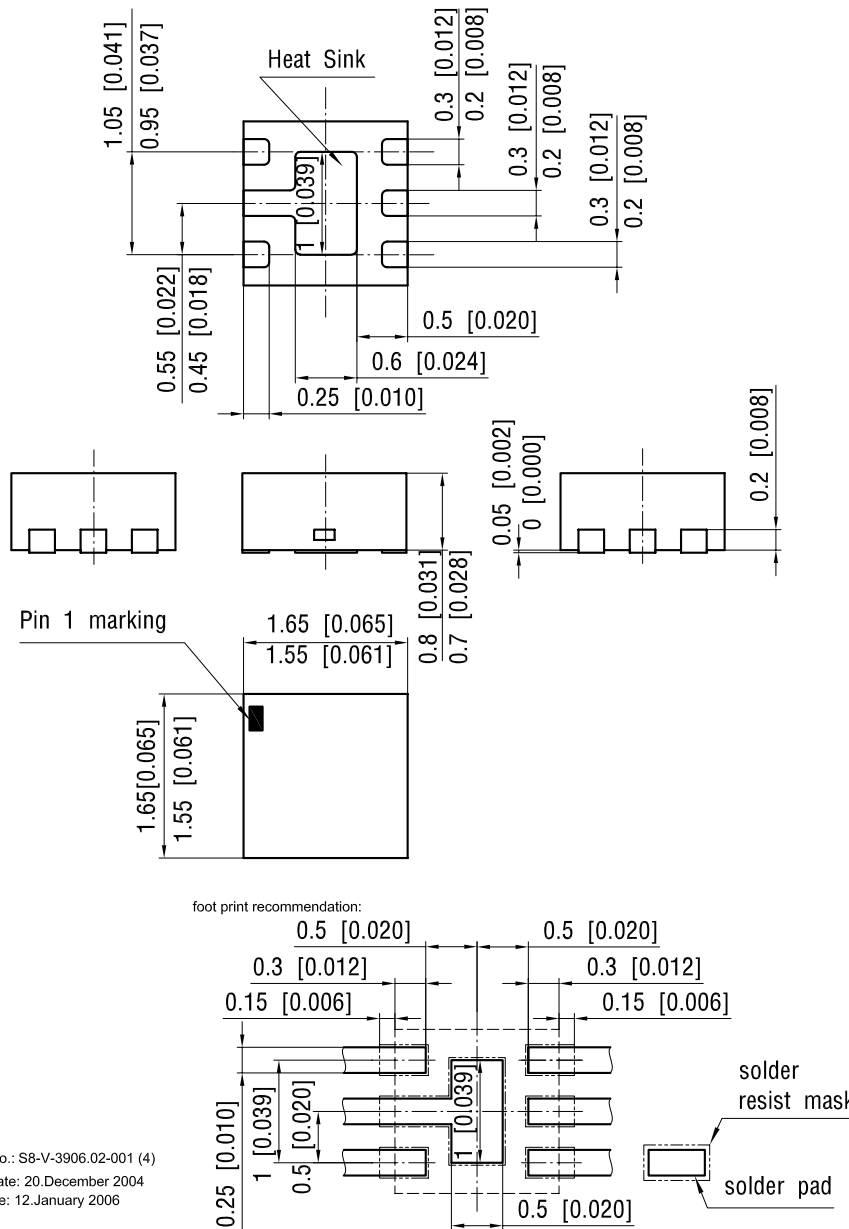
Package Dimensions in mm (Inches)



Document no.: S8-V-3906.02-001 (4)
 Created - Date: 20.December 2004
 Rev. b - Date: 12.January 2006
 18058

LLP75-6A

Package Dimensions in mm (Inches)



Document no.: S8-V-3906.02-001 (4)
 Created - Date: 20.December 2004
 Rev. b - Date: 12.January 2006
 18058

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View GMF05C-HS3-GS08 on WIN SOURCE](#)

 [Vishay Information](#)

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management